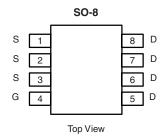
**RoHS** 

COMPLIANT HALOGEN FREE Available



## N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
30	0.0095 at V <sub>GS</sub> = 10 V	18.2	9.2 nC		
	0.014 at V <sub>GS</sub> = 4.5 V	15	9.2110		



Ordering Information: Si4686DY-T1-E3 (Lead (Pb)-free)

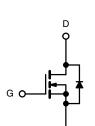
Si4686DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 **Available**
- Extremely Low Q<sub>gd</sub> WFET<sup>®</sup> Technology for Low Switching Losses
- TrenchFET® Power MOSFETs
- 100 % R<sub>a</sub> Tested

#### **APPLICATIONS**

- High-Side DC/DC Conversion
  - Notebook
  - Server



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	30	<u> </u>		
Gate-Source Voltage		V <sub>GS</sub>	± 20	_ v	
	T <sub>C</sub> = 25 °C		18.2		
Continuous Dusin Commant /T 450 90)	T <sub>C</sub> = 70 °C		14.5		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	13.8 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		11 <sup>b, c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	50	_ A	
Ocation of Community Blade Ocases	T <sub>C</sub> = 25 °C	1	4.3		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	ls –	2.5 <sup>b, c</sup>		
Single-Pulse Avalanche Current		I <sub>AS</sub>	10		
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	5	mJ	
	T <sub>C</sub> = 25 °C		5.2		
M	T <sub>C</sub> = 70 °C		3.3		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.0 <sup>b, c</sup>	w	
	T <sub>A</sub> = 70 °C		1.9 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature					

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	$R_{thJA}$	35	42	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	20	24	] 5/**		

#### Notes:

- a. Based on  $T_C$  = 25 °C. b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 80 °C/W.

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<b>SPECIFICATIONS</b> $T_J = 25  ^{\circ}\text{C}$ Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static		1000 001141110110		.,,,,	1		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			31.3		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 6			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1		3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$		1	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
	, ,	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 13.8 A		0.0078	0.0095		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 11.4 A		0.011	0.014	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 13.8 A		56		S	
Dynamic <sup>b</sup>					l		
Input Capacitance	C <sub>iss</sub>			1220		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		230			
Reverse Transfer Capacitance	C <sub>rss</sub>			98			
Tatal Cata Chausa		V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 13.8 A		17	26	nC	
Total Gate Charge	$Q_g$			9.2	14		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 13.8 \text{ A}$		4.1			
Gate-Drain Charge	$Q_{gd}$			2.8			
Gate Resistance	$R_g$	f = 1 MHz		0.8	1.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		20	30		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		20	30		
Fall Time	t <sub>f</sub>			8	15		
Turn-On Delay Time	t <sub>d(on)</sub>			13	20	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		16	25	= -	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		23	35		
Fall Time	t <sub>f</sub>			8	15		
<b>Drain-Source Body Diode Characteris</b>	tics			•	•		
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			4.3	^	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	A	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 2.6 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			25	50	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	r I <sub>F</sub> = 2.6 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		15	30	nC	
Reverse Recovery Fall Time	t <sub>a</sub>			12.5		nc	
Reverse Recovery Rise Time	t <sub>b</sub>			12.5		ns	

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

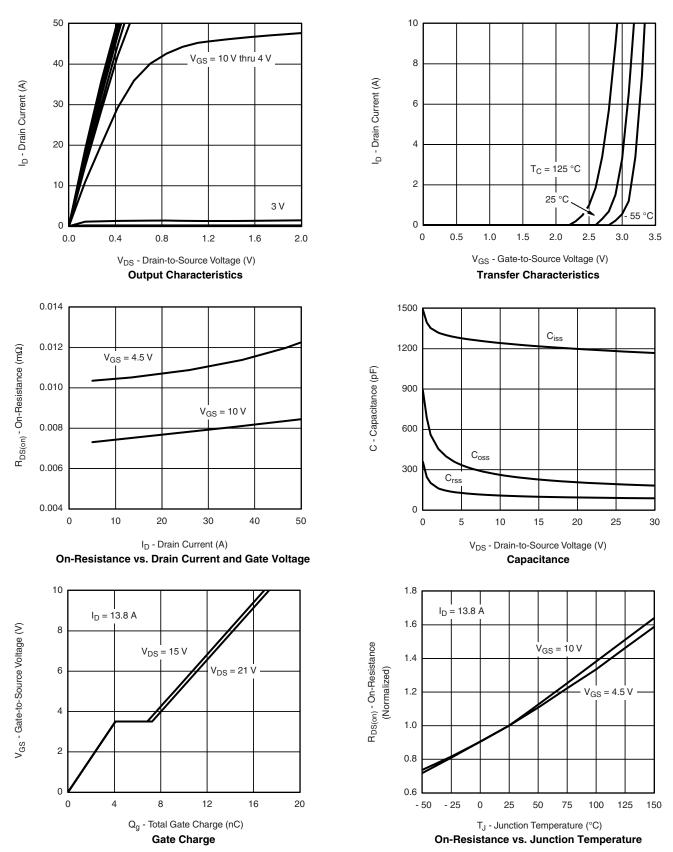
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.







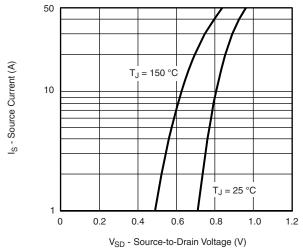
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



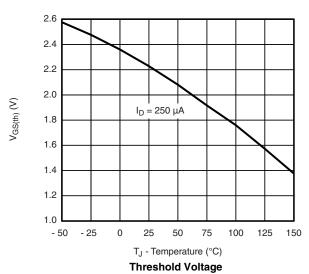
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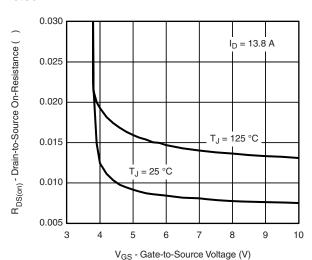
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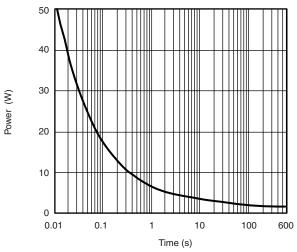


#### Source-Drain Diode Forward Voltage

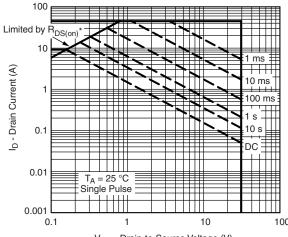




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



 $V_{DS} \text{ - Drain-to-Source Voltage (V)} \\ ^*V_{GS} \text{ > minimum } V_{GS} \text{ at which } R_{DS(on)} \text{ is specified}$ 

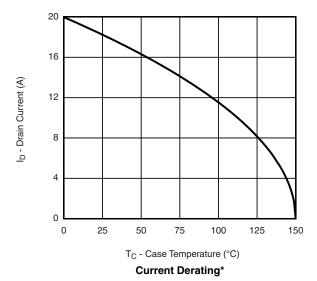
Safe Operating Area, Junction-to-Ambient

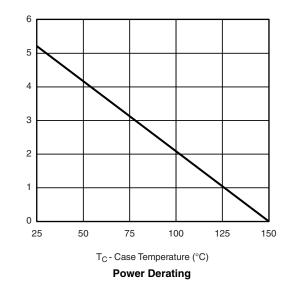






### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





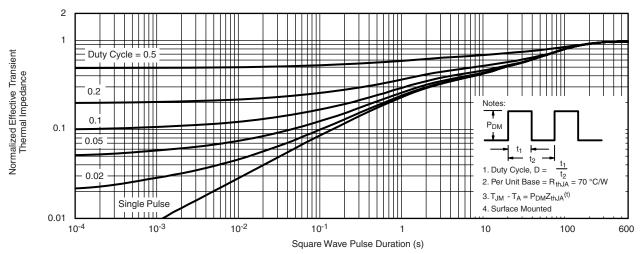
Power (W)

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

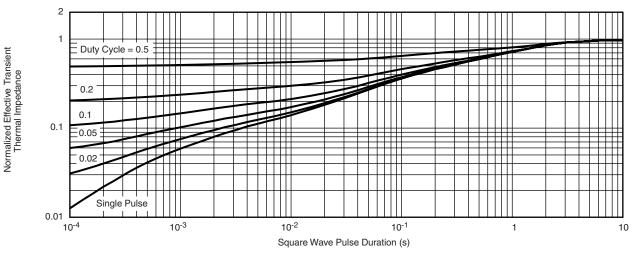
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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